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PATENT  
SP01-325

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

**Applicant(s):** Kishor P. Gadkaree

Joseph F. Mach

**Serial No.:** 09/991,401

**Filing Date:** November 20, 2001

**Title:** COMPRESSION-MOLDED SILICON  
CARBIDE STRUCTURES

Group Art Unit: 1732

Examiner:

**INFORMATION DISCLOSURE STATEMENT**

Assistant Commissioner for Patents  
Washington, DC 20231

Applicant(s) or their undersigned representative know of no art that adversely affects the patentability of the present claims.

Respectfully submitted,

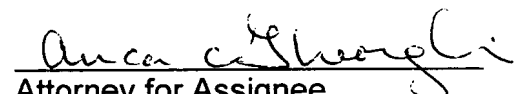
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I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date indicated above with sufficient postage as first class mail in an envelope addressed to the: Assistant Commissioner for Patents, Washington, DC 20231

Signature

  
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